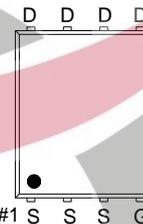
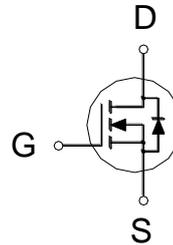




PRODUCT SUMMARY

| | | |
|---------------|----------------|---------|
| $V_{(BR)DSS}$ | $R_{DS(ON)}$ | I_D^4 |
| 30V | 0.99m Ω | 229A |



G. GATE
D. DRAIN
S. SOURCE

100% UIS Tested
100% Rg Tested

Features

- Pb-Free, Halogen Free and RoHS compliant.
- Low $R_{DS(on)}$ to Minimize Conduction Losses.
- Ohmic Region Good $R_{DS(on)}$ Ratio.
- Optimized Gate Charge to Minimize Switching Losses.

Applications

- Protection Circuits Applications.
- Computer for DC to DC Converters Applications.

ABSOLUTE MAXIMUM RATINGS ($T_A = 25\text{ }^\circ\text{C}$ Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS | | SYMBOL | LIMITS | UNITS |
|--|-----------------------------------|----------------|------------|------------------|
| Drain-Source Voltage | | V_{DS} | 30 | V |
| Gate-Source Voltage | | V_{GS} | ± 20 | V |
| Continuous Drain Current ⁴ | $T_C = 25\text{ }^\circ\text{C}$ | I_D | 229 | A |
| | $T_C = 100\text{ }^\circ\text{C}$ | | 145 | |
| Pulsed Drain Current ¹ | | I_{DM} | 350 | |
| Continuous Drain Current | $T_A = 25\text{ }^\circ\text{C}$ | I_D | 50 | |
| | $T_A = 70\text{ }^\circ\text{C}$ | | 40 | |
| Avalanche Current | | I_{AS} | 86 | |
| Avalanche Energy | | E_{AS} | 369.8 | mJ |
| Power Dissipation | $T_C = 25\text{ }^\circ\text{C}$ | P_D | 104 | W |
| | $T_C = 100\text{ }^\circ\text{C}$ | | 41 | |
| Power Dissipation ³ | $T_A = 25\text{ }^\circ\text{C}$ | P_D | 5 | W |
| | $T_A = 70\text{ }^\circ\text{C}$ | | 3.2 | |
| Operating Junction & Storage Temperature Range | | T_j, T_{stg} | -55 to 150 | $^\circ\text{C}$ |

THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE | | SYMBOL | TYPICAL | MAXIMUM | UNITS |
|----------------------------------|--------------|-----------------|---------|---------|--------|
| Junction-to-Ambient ² | $t \leq 10s$ | $R_{\theta JA}$ | | 25 | °C / W |
| Junction-to-Ambient ² | Steady-State | $R_{\theta JA}$ | | 40 | |
| Junction-to-Case | Steady-State | $R_{\theta JC}$ | | 1.2 | |

¹Pulse width limited by maximum junction temperature.

²The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ C$.

³The Power dissipation is based on $R_{\theta JA}$ $t \leq 10s$ value.

⁴The maximum current rating is package limited.

ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ C$, Unless Otherwise Noted)

| PARAMETER | SYMBOL | TEST CONDITIONS | LIMITS | | | UNIT | |
|---|---------------|--|---|------|-----------|------------|----|
| | | | MIN | TYP | MAX | | |
| STATIC | | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$ | 30 | | | V | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_D = 250\mu A$ | 1.35 | 1.8 | 2.35 | | |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0V, V_{GS} = \pm 20V$ | | | ± 100 | nA | |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 24V, V_{GS} = 0V$ | | | 1 | μA | |
| | | $V_{DS} = 20V, V_{GS} = 0V, T_J = 55^\circ C$ | | | 10 | | |
| Drain-Source On-State Resistance ¹ | $R_{DS(ON)}$ | $V_{GS} = 4.5V, I_D = 20A$ | | 1.2 | 1.5 | m Ω | |
| | | $V_{GS} = 10V, I_D = 20A$ | | 0.85 | 0.99 | | |
| Forward Transconductance ¹ | g_{fs} | $V_{DS} = 5V, I_D = 20A$ | | 123 | | S | |
| DYNAMIC | | | | | | | |
| Input Capacitance | C_{iss} | $V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$ | | 6151 | | pF | |
| Output Capacitance | C_{oss} | | | 1052 | | | |
| Reverse Transfer Capacitance | C_{rss} | | | 693 | | | |
| Gate Resistance | R_g | $V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$ | | 1.7 | | Ω | |
| Total Gate Charge ² | Q_g | $V_{GS} = 10V$ | $V_{DS} = 15V, V_{GS} = 10V, I_D = 20A$ | | 128 | nC | |
| | | $V_{GS} = 4.5V$ | | | 65 | | |
| Gate-Source Charge ² | Q_{gs} | | | 19.7 | | | |
| Gate-Drain Charge ² | Q_{gd} | | | 24 | | | |
| Turn-On Delay Time ² | $t_{d(on)}$ | $V_{DS} = 15V, I_D \cong 20A, V_{GS} = 10V, R_{GEN} = 6\Omega$ | | | 27 | | nS |
| Rise Time ² | t_r | | | | 49 | | |
| Turn-Off Delay Time ² | $t_{d(off)}$ | | | | 171 | | |
| Fall Time ² | t_f | | | 90 | | | |

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T_J = 25 °C)

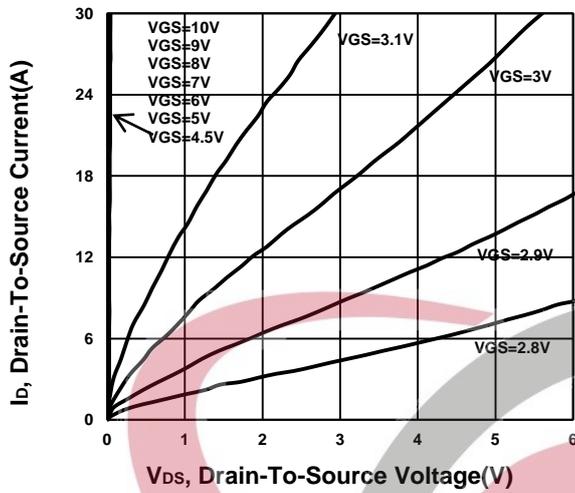
| | | | | | |
|------------------------------|-----------------|---|--|-----|----|
| Continuous Current | I _S | | | 104 | A |
| Forward Voltage ¹ | V _{SD} | I _F = 20A, V _{GS} = 0V | | 1 | V |
| Reverse Recovery Time | t _{rr} | I _F = 20A, di _F /dt = 100A / μS | | 46 | nS |
| Reverse Recovery Charge | Q _{rr} | | | 36 | nC |

¹Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

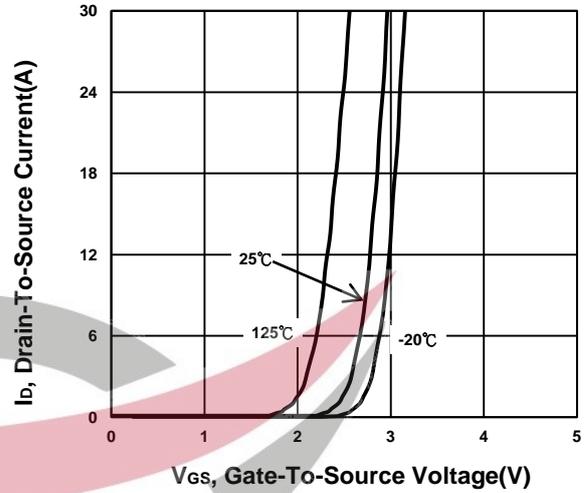
²Independent of operating temperature.



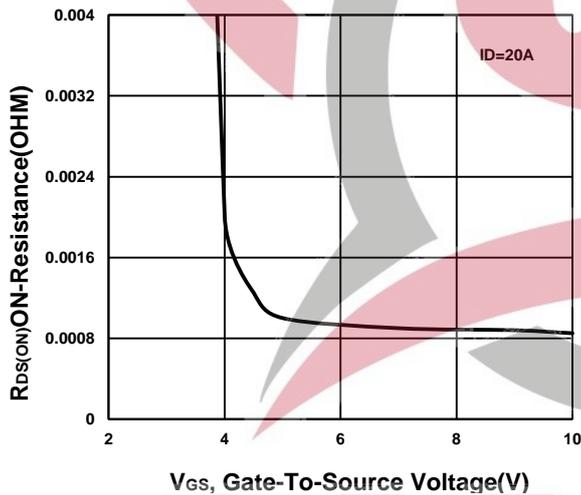
Output Characteristics



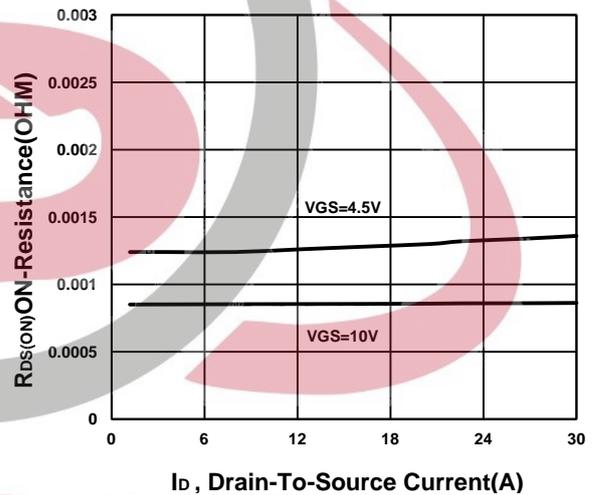
Transfer Characteristics



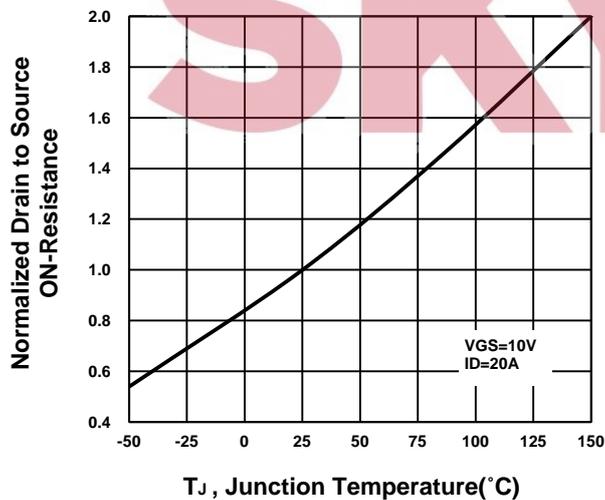
On-Resistance VS Gate-To-Source



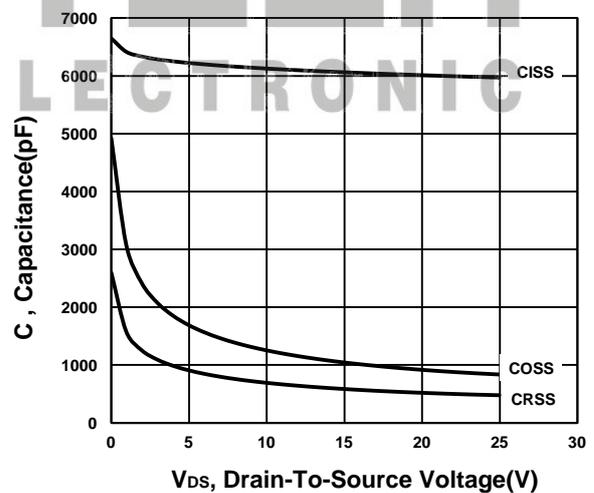
On-Resistance VS Drain Current



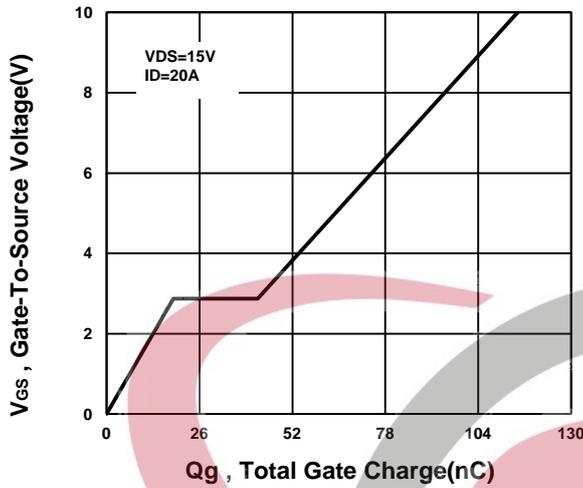
On-Resistance VS Temperature



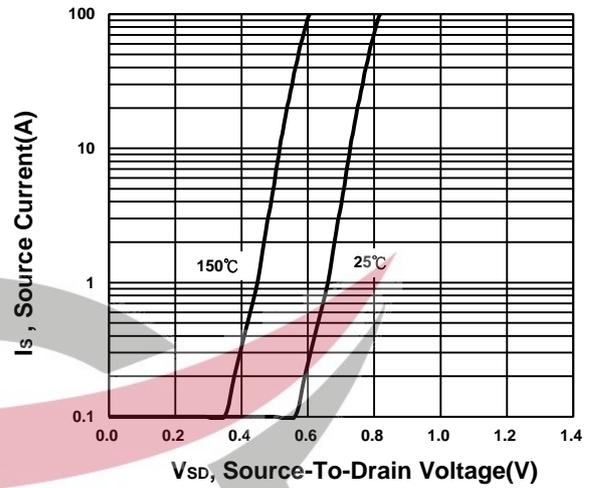
Capacitance Characteristic



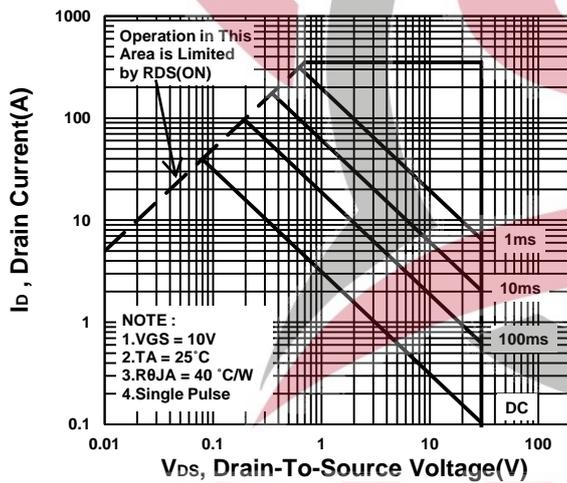
Gate charge Characteristics



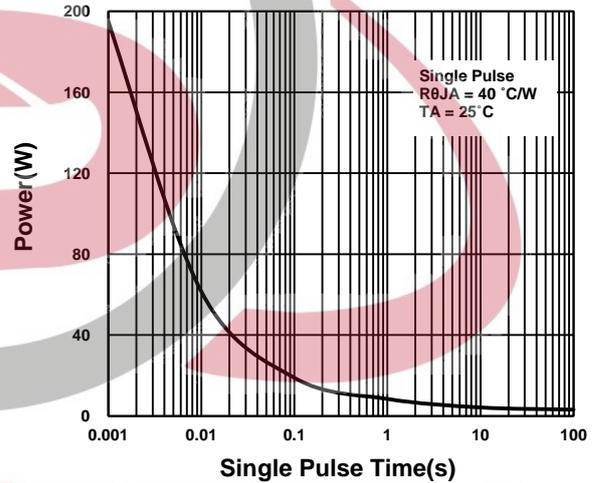
Source-Drain Diode Forward Voltage



Safe Operating Area



Single Pulse Maximum Power Dissipation



Transient Thermal Response Curve

